Sir:

minsmitted herewith for filing is the Patent Application of:

Entor: SHENG-CHI CHIN AND SHY-JAY LIN

THE COMMISSIONER OF PATENTS

Washington, D.C.

A METHOD TO REDUCE PARTICLE LEVEL FOR DRY-ETCH

For: Enclosed are:

=6

- 5 sheets of drawing(s) formal.
- An assignment of the invention to Taiwan Semiconductor Manufacturing Company
- An associate power of attorney

The filing fee has been calculated as shown below:

<u> </u>	(Col. 1)	(Col. 2)	OTHER THAN A	SMALL ENTITY
FOR:	NO. FILED	NO. EXTRA	RATE	FEE
BASIC FEE	><			\$ 760.
TOTAL CLAIMS	22 -20=	2	x 18 =	\$ 36.
INDEP CLAIMS	2 -3=	0	x 78 =	\$ 0.
MULTIPLE DEPENDENT CLAIM PRESENTED + 260 =				
		s	UB TOTAL	\$ 796.
		A	SSIGNMENT	\$40.
<u>\$</u>		T	OTAL	\$ 836.

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- Any additional filing fees required under 37 CFR §1.16.
- Any patent application processing fees under 37 CFR §1.17.

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